

### FEATURES

- Available as "HR" (high reliability) screened per MIL-PRF-19500, JANTX level. Add "HR" suffix to base part number.
- Available as non-RoHS (Sn/Pb plating), standard, and as RoHS by adding "-PBF" suffix.

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
<b>Peak forward reverse blocking voltage</b> MCR1000-4 MCR1000-6 MCR1000-8	$V_{DRM}$ , $V_{RRM}$	200 400 600	Volts
<b>Forward current RMS</b> (all conduction angles, $T_C = 25^\circ\text{C}$ )	$I_{T(RMS)}$	15	Amps
<b>Peak forward surge current</b> (1/2 cycle, sine wave, 60 Hz, $T_J = 125^\circ\text{C}$ )	$I_{TSM}$	90	Amps
<b>Circuit fusing considerations</b> ( $T_J = 0$ to $+125^\circ\text{C}$ , $t = 1$ to 8.3ms)	$I^2t$	34	$\text{A}^2\text{s}$
<b>Forward peak gate voltage</b>	$V_{GM}$	$\pm 20$	Volts
<b>Forward peak gate current</b>	$I_{GM}$	1.5	Amps
<b>Operating junction temperature range</b>	$T_J$	0 to $+125$	$^\circ\text{C}$
<b>Storage temperature range</b>	$T_{stg}$	-65 to $+150$	$^\circ\text{C}$

### THERMAL CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Maximum	Unit
<b>Thermal resistance, junction to case</b>	$R_{\theta JC}$	1.67	$^\circ\text{C}/\text{W}$

### ELECTRICAL CHARACTERISTICS ( $R_{GK} = 1000\Omega$ )

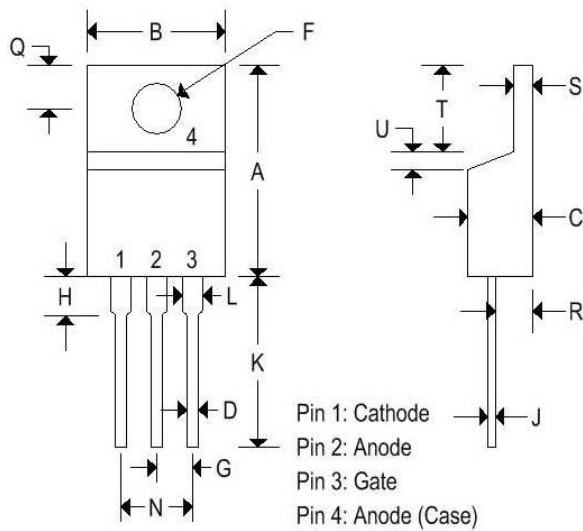
Characteristic	Symbol	Min	Typ.	Max	Unit
<b>Peak forward blocking current</b> (Rated $V_{DRM}$ @ $T_J = 125^\circ\text{C}$ )	$I_{DRM}$	-	-	2.0	mA
<b>Peak reverse blocking current</b> (Rated $V_{RRM}$ @ $T_J = 125^\circ\text{C}$ )	$I_{RRM}$	-	-	2.0	mA
<b>Peak reverse blocking voltage</b>	$V_{RRM}$	-	-	100	Volts
<b>Forward "on" voltage</b> ( $I_{TM} = 20\text{A}$ peak)	$V_{TM}$	-	3.5	4.0	Volts
<b>Gate trigger voltage</b> (continuous dc) ( $V_{AK} = 12\text{Vdc}$ , $R_L = 100\Omega$ ) ( $V_{AK} = \text{Rated } V_{DRM}$ , $R_L = 100\Omega$ , $T_J = 125^\circ\text{C}$ )	$V_{GT}$ $V_{GD}$	- 0.2	2.0 -	2.5 -	Volts
<b>Holding current</b> ( $V_{AK} = 12\text{Vdc}$ )	$I_H$	-	10	40	mA
<b>Turn on time</b> See Figure 6	$t_{gt}$	-	-	200	ns
<b>Turn off time</b> ( $V_{DRM} = \text{rated voltage}$ ) ( $I_{TM} = 3.0\text{A}$ , $I_R = 2.0\text{A}$ , $dv/dt = 100\text{V}/\mu\text{s}$ )	$t_q$	-	6.0	8.0	$\mu\text{s}$
<b>Forward voltage application rate</b> ( $T_J = 125^\circ\text{C}$ , $R_{GK} \leq 200\Omega$ ) (Figure 7)	$dv/dt$	1000	-	-	$\text{V}/\mu\text{s}$
<b>Maximum rate of change of on state current</b> (Rated $V_{DRM}$ , $I_{TM} = 20\text{A}$ , $T_J = 125^\circ\text{C}$ )	$di/dt$	-	-	100	$\text{A}/\mu\text{s}$

# MCR1000 SERIES

## SILICON CONTROLLED RECTIFIERS

### MECHANICAL CHARACTERISTICS

<b>Case:</b>	TO-220AB
<b>Marking:</b>	Body painted, alpha-numeric
<b>Pin out:</b>	See below

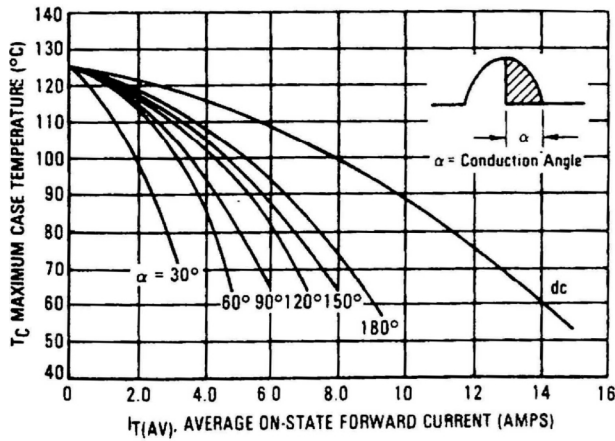


	TO-220AB			
	Inches		Millimeters	
	Min	Max	Min	Max
A	0.575	0.620	14.600	15.750
B	0.380	0.405	9.650	10.290
C	0.160	0.190	4.060	4.820
D	0.025	0.035	0.640	0.890
F	0.142	0.147	3.610	3.730
G	0.095	0.105	2.410	2.670
H	0.110	0.155	2.790	3.930
J	0.014	0.022	0.360	0.560
K	0.500	0.562	12.700	14.270
L	0.045	0.055	1.140	1.390
N	0.190	0.210	4.830	5.330
Q	0.100	0.120	2.540	3.040
R	0.080	0.110	2.040	2.790
S	0.045	0.055	1.140	1.390
T	0.235	0.255	5.970	6.480
U	-	0.050	-	1.270
V	0.045	-	1.140	-
Z	-	0.080	-	2.030

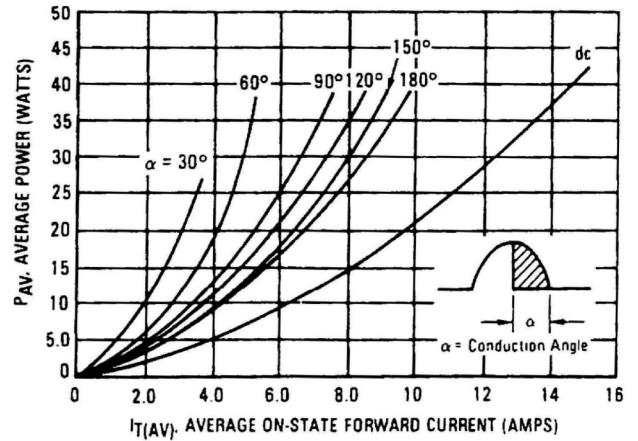
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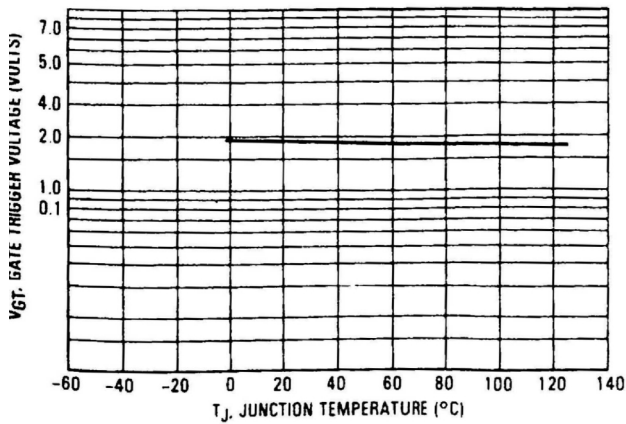
**FIGURE 1 — AVERAGE CURRENT DERATING**



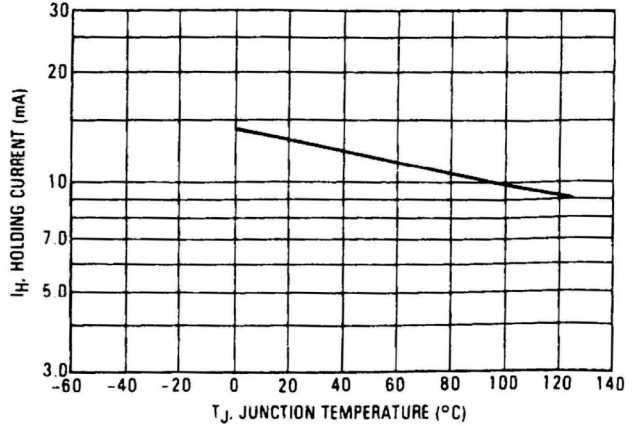
**FIGURE 2 — MAXIMUM ON-STATE POWER DISSIPATION**



**FIGURE 3 — TYPICAL GATE TRIGGER VOLTAGE**



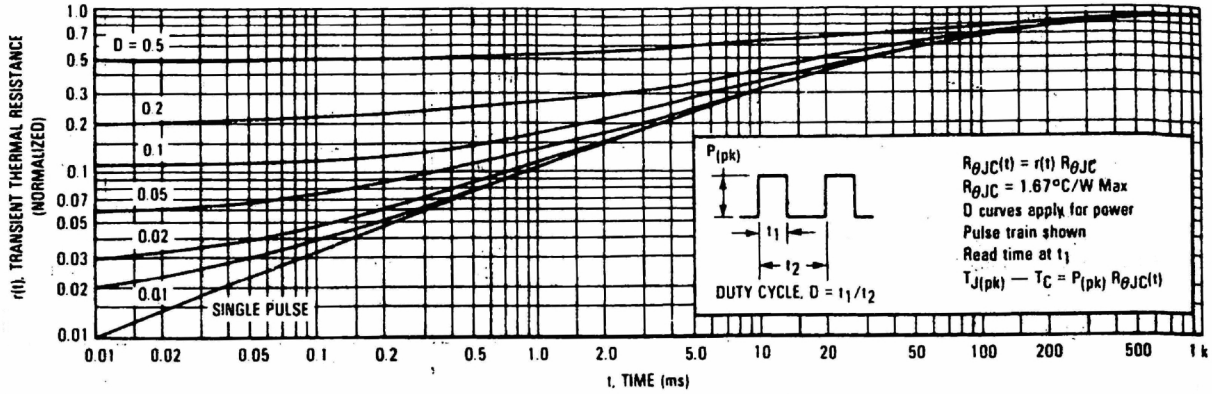
**FIGURE 4 — TYPICAL HOLDING CURRENT**



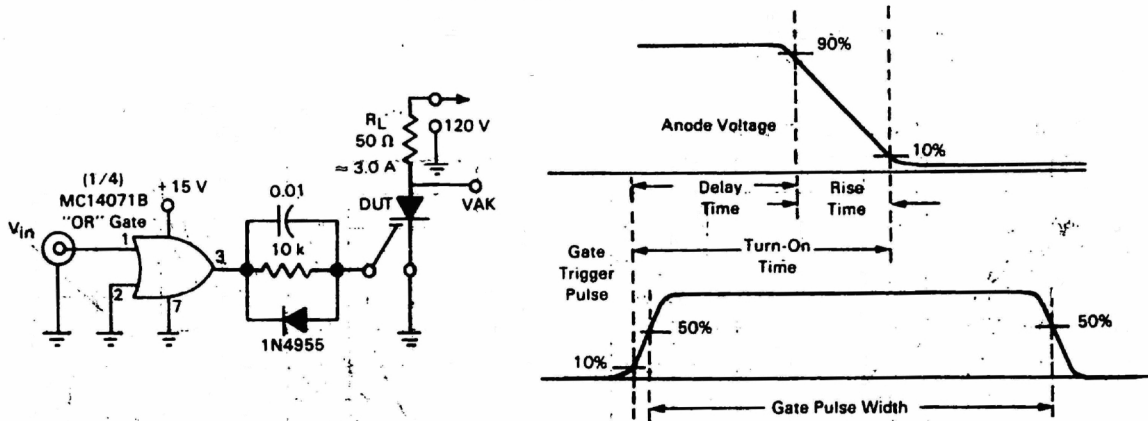
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## SILICON CONTROLLED RECTIFIERS

**FIGURE 5 – THERMAL RESPONSE**



**FIGURE 6 – MCR1000 SERIES TYPICAL TURN-ON CIRCUIT WITH CMOS GATING**



**FIGURE 7 – TYPICAL dv/dt CAPABILITY**

